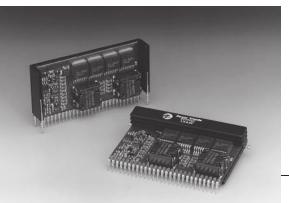


32 Amp "Sledge Hammer" **Programmable ISR**



SLTS054A

(Revised 6/30/2000)



The PT7771 is a high-output Integrated Switching Regulator (ISR) housed in a 27-pin SIP package. The PT7771 operates off a standard 5V bus to provide a 32 amp low-voltage power source for the industry's latest highspeed µPs, ASICs, DSPs.

The PT7771 has been designed to work in parallel with one or more of the PT7746 -32A current boosters to increase the load current capability in increments of 32A.

The output voltage is programmable from 1.3V to 3.5V via a 5-bit input, compatible with Intel's Pentium^a Pro Processor. A differential remote sense is also provided to compensate for voltage drop between the ISR and load.

An output capacitance of 2400µF is required for proper operation.

Note that this product does not include short circuit protection.

Standard Application PROGRAMMING PINS REMOTE SENSE (+) L1 PT7770 ΊĤ CIN Cout LOAD SYNC OUT GND GND STBY* REMOTE SENSE (-)

Pin-Out Information

Pin	Function	Pin	Function
1	VID0	14	GND
2	VID1	15	GND
3	VID2	16	GND
4	VID3	17	GND
5	STBY*- Stand-by	18	GND
6	VID4	19	GND
7	V _{in}	20	Vout
8	V _{in}	21	Vout
9	\mathbf{V}_{in}	22	Vout
10	V _{in}	23	Vout
11	V _{in}	24	Vout
12	Remote Sense Gnd	25	V _{out}
13	GND	26	Remote Sense V_{out}
		27	Sync Out

For STBY* pin; open = output enabled; ground = output disabled.

Specifications

Characteristics						
(T _a = 25°C unless noted)	Symbols	Conditions	Min	Тур	Max	Units
Output Current	Io	$T_a = +60^{\circ}C$, 200 LFM, pkg N $T_a = +25^{\circ}C$, natural convection	0.1 (1) 0.1 (1)	_	32 26	A A
Input Voltage Range	Vin	$0.1A \le I_o \le 32A$	4.5 (2)	_	5.5	V
Output Voltage Tolerance	ΔV_{o}	$V_{in} = +5V$, $I_o = 32A$ 0°C $\leq T_a \leq +55$ °C	Vo-0.03	—	Vo+0.03	V
Line Regulation	Regline	$4.5V \leq V_{in} \leq 5.5V \text{, } I_o$ = 32A		±10	_	mV
Load Regulation	Reg _{load}	$V_{in} = +5V, 0.1 \le I_o \le 32A$		±10		mV
V _o Ripple/Noise pk-pk	Vn	$V_{in} = +5V$, $I_o = 32A$		50	_	mV
Transient Response with C _{out} = 2400µF	${f t_{tr}}{V_{os}}$	I _o step between 16A and 32A V _o over/undershoot	_	100 200	_	μSec mV
Efficiency	η	$V_{in} = +5V, I_o = 20A, V_o = 3.3V$		90	_	%
Switching Frequency	$f_{ m o}$	$\begin{array}{l} 4.5\mathrm{V} \leq \mathrm{V_{in}} \leq 5.5\mathrm{V} \\ 0.1\mathrm{A} \leq \mathrm{I_o} \leq 32\mathrm{A} \end{array}$	650	700	750	kHz
Absolute Maximum Operating Temperature Range	Ta	Over V _{in} Range	0	_	+85 ⁽³⁾	°C
Storage Temperature	Ts	_	-40	_	+125	°C
Weight		Vertical/Horizontal		53/66	_	grams

Notes: (1) ISR-will operate down to no load with reduced specifications. Please note that this product is not short-circuit protected.

(2) The minimum input voltage is 4.5V or $V_{out} + 1.2V$, whichever is greater.

(3) Consult the SOA curves or contact the factory for the appropriate derating.

Output Capacitors: The PT7771 regulator requires a minimum output capacitance of 2400µF for proper operation. Do not use Oscon type capacitors. The maximum allowable output capacitance is 30,000µF.

Input Filter: An input filter is optional for most applications. The input inductor must be sized to bandle 32ADC with a typical value of 1µH. The input capacitance must be rated for a minimum of 2.6Arms of ripple current. For transient or dynamic load applications, additional capacitance may be required.



PT7771—5V

32 Amp "Sledge Hammer" Programmable ISR

Features

- +5V input
- 5-bit Programmable: 1.3V to 3.5V@32A
- High Efficiency
- Differential Remote Sense
- Parallelable with PT7746 32A "Current Booster"
- 27-pin SIP Package

Programming Information

		0				
VID3	VID2	VID1	VIDO	VID4=1 Vout	VID4=0 Vout	
1	1	1	1	2.0V	1.30V	
1	1	1	0	2.1V	1.35V	
1	1	0	1	2.2V	1.40V	
1	1	0	0	2.3V	1.45V	
1	0	1	1	2.4V	1.50V	
1	0	1	0	2.5V	1.55V	
1	0	0	1	2.6V	1.60V	
1	0	0	0	2.7V	1.65V	
0	1	1	1	2.8V	1.70V	
0	1	1	0	2.9V	1.75V	
0	1	0	1	3.0V	1.80V	
0	1	0	0	3.1V	1.85V	
0	0	1	1	3.2V	1.90V	
0	0	1	0	3.3V	1.95V	
0	0	0	1	3.4V	2.00V	
0	0	0	0	3.5V	2.05V	

Logic 0 = Pin 12 potential (remote sense gnd) Logic 1 = Open circuit (no pull-up resistors) VID3 and VID4 may not be changed while the unit

is operating.

Ordering Information

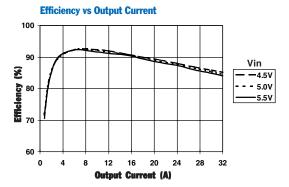
PT7771 = 1.3 to 3.5 Volts For dimensions and PC board layout, see Package Style 1020 and 1030

PT Series Suffix (PT1234X)

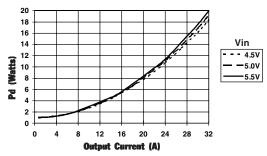
Case/Pin Configuration						
Vertical Through-Hole	N					
Horizontal Through-Hole	Α					
Horizontal Surface Mount	С					

TYPICAL CHARACTERISTICS

PT7771 @Vin =+5V, Vout =3.3V (See Note A)

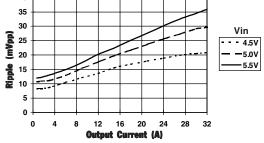


Power Dissipation vs Output Current





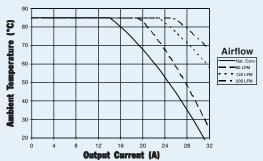
🤣 Texas Instruments



Note A: All characteristic data in the above graphs has been developed from actual procducts tested at 25°C. This data is considered typical for the ISR. **Note B:** OA curves represent operating conditions at which internal components are at or below manufacturer's maximum rated operating temperatures.

Safe Operating Area Curves (See Note B)







2-Feb-2014

PACKAGING INFORMATION

Orderable Device	Status	Package Type	Package	Pins F	Package	Eco Plan	Lead/Ball Finish	MSL Peak Temp	Op Temp (°C)	Device Marking	Samples
	(1)		Drawing		Qty	(2)	(6)	(3)		(4/5)	
PT7771N1	OBSOLET	SIP MODULE	EJD	27		TBD	Call TI	Call TI			

⁽¹⁾ The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSOLETE: TI has discontinued the production of the device.

(2) Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS & no Sb/Br) - please check http://www.ti.com/productcontent for the latest availability information and additional product content details.

TBD: The Pb-Free/Green conversion plan has not been defined.

Pb-Free (RoHS): TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

Pb-Free (RoHS Exempt): This component has a RoHS exemption for either 1) lead-based flip-chip solder bumps used between the die and package, or 2) lead-based die adhesive used between the die and leadframe. The component is otherwise considered Pb-Free (RoHS compatible) as defined above.

Green (RoHS & no Sb/Br): TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

⁽³⁾ MSL, Peak Temp. - The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

⁽⁴⁾ There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.

(5) Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.

⁽⁶⁾ Lead/Ball Finish - Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead/Ball Finish values may wrap to two lines if the finish value exceeds the maximum column width.

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